


Remarks

The specification at page 1 has been amended to identify the application of which this is a divisional.

At page 4, an inadvertent error in the number of the prior art patent disclosing a process for fabricating SMA material in thin film form has been corrected. This same amendment was made in the parent application of which this is a divisional.

The foregoing amendments do not introduce new matter; thus entry of the amendments are considered to be in order and such action is solicited.

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